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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



Devices in the MB9B560R Series are highly integrated 32-bit microcontrollers with high performance and competitive cost.

This series is based on the ARM® Cortex®-M4F Processor with on-chip Flash memory and SRAM. The series has peripheral functions such as Motor Control Timers, ADCs and Communication Interfaces (USB, CAN, UART, CSIO, I²C, LIN).

Features

32-bit ARM® Cortex®-M4F Core

- Processor version: r0p1
- Up to 160 MHz Frequency Operation
- FPU built-in
- Support DSP instruction
- Memory Protection Unit (MPU): improves the reliability of an embedded system
- Integrated Nested Vectored Interrupt Controller (NVIC): 1 NMI (non-maskable interrupt) and 128 peripheral interrupts and 16 priority levels
- 24-bit System timer (Sys Tick): System timer for OS task management

On-chip Memories

[Flash memory]

These series are based on two independent on-chip Flash memories.

- MainFlash memory
 - Up to 1024 Kbytes
 - Built-in Flash Accelerator System with 16 Kbytes trace buffer memory
 - The read access to Flash memory can be achieved without wait-cycle up to operation frequency of 72 MHz. Even at the operation frequency more than 72 MHz, an equivalent access to Flash memory can be obtained by Flash Accelerator System.
 - Security function for code protection
- WorkFlash memory
 - 32 Kbytes
 - Read cycle:
 - 6wait-cycle: the operation frequency more than 120 MHz, and up to 160 MHz
 - 4wait-cycle: the operation frequency more than 72 MHz, and up to 120 MHz
 - 2wait-cycle: the operation frequency more than 40 MHz, and up to 72 MHz
 - 0wait-cycle: the operation frequency up to 40 MHz
 - Security function is shared with code protection

[SRAM]

This is composed of three independent SRAMs (SRAM0, SRAM1, and SRAM2). SRAM0 is connected to I-code bus and D-code bus of Cortex-M4F core. SRAM1 and SRAM2 are connected to System bus of Cortex-M4F core.

- SRAM0: Up to 64 Kbytes
- SRAM1: Up to 32 Kbytes
- SRAM2: Up to 32 Kbytes

External Bus Interface

- Supports SRAM, NOR, NAND Flash, and SDRAM device
- Up to 9 chip selects CS0 to CS8 (CS8 is only for SDRAM)
- 8-/16-bit Data width
- Up to 25-bit Address bit
- Maximum Access size: 256M byte
- Supports Address/Data multiplex
- Supports external RDY function
- Supports scramble function
 - Possible to set the validity/invalidity of the scramble function for the external areas 0x6000_0000 to 0xDFFF_FFFF in 4 Mbytes units.
 - Possible to set two kinds of the scramble key
 - **Note:** It is necessary to prepare the dedicated software library to use the scramble function.

USB Interface

USB interface is composed of Device and Host.

[USB device]

- USB2.0 Full-Speed supported
- Max 6 Endpoint supported
 - Endpoint 0 is control transfer
 - Endpoint 1, 2 can be selected Bulk-transfer, Interrupt-transfer or Isochronous-transfer
 - Endpoint 3 to 5 can select Bulk-transfer or Interrupt-transfer
 - Endpoint 1 to 5 comprise Double Buffer
 - The size of each endpoint is according to the follows.
 - Endpoint 0, 2 to 5: 64 bytes
 - Endpoint 1: 256 bytes

[USB host]

- USB2.0 Full/Low-speed supported
- Bulk-transfer, interrupt-transfer and Isochronous-transfer support
- USB Device connected/dis-connected automatically detect
- IN/OUT token handshake packet automatically
- Max 256-byte packet-length supported
- Wake-up function supported

CAN Interface (Max two channels)

- Compatible with CAN Specification 2.0A/B
- Maximum transfer rate: 1 Mbps
- Built-in 32 message buffer

Multi-function Serial Interface (Max eight channels)

- 64 bytes with FIFO (the FIFO step numbers are variable depending on the settings of the communication mode or bit length.)
- Operation mode is selectable from the followings for each channel.
 - UART
 - CSIO
 - LIN
 - I²C
- UART
 - Full-duplex double buffer
 - Selection with or without parity supported
 - Built-in dedicated baud rate generator
 - External clock available as a serial clock
 - Hardware Flow control : Automatically control the transmission by CTS/RTS (only ch.4)
 - Various error detect functions available (parity errors, framing errors, and overrun errors)
- CSIO
 - Full-duplex double buffer
 - Built-in dedicated baud rate generator
 - Overrun error detect function available
 - Serial chip select function (ch.6 and ch.7 only)
 - Supports high-speed SPI (ch.4 and ch.6 only)
 - Data length 5 to 16-bit
- LIN
 - LIN protocol Rev.2.1 supported
 - Full-duplex double buffer
 - Master/Slave mode supported
 - LIN break field generation (can change to 13 to 16-bit length)
 - LIN break delimiter generation (can change to 1 to 4-bit length)
 - Various error detect functions available (parity errors, framing errors, and overrun errors)

■ I²C

- Standard-mode (Max 100 kbps) / Fast-mode (Max 400 kbps) supported
- Fast-mode Plus (Fm+) (Max 1000 kbps, only for ch.3=ch.A and ch.7=ch.B) supported

DMA Controller (Eight channels)

DMA Controller has an independent bus for CPU, so CPU and DMA Controller can process simultaneously.

- 8 independently configured and operated channels
- Transfer can be started by software or request from the built-in peripherals
- Transfer address area: 32-bit (4 Gbytes)
- Transfer mode: Block transfer/Burst transfer/Demand transfer
- Transfer data type: bytes/half-word/word
- Transfer block count: 1 to 16
- Number of transfers: 1 to 65536

DSTC (Descriptor System data Transfer Controller) (128 channels)

The DSTC can transfer data at high-speed without going via the CPU. The DSTC adopts the Descriptor system and, following the specified contents of the Descriptor which has already been constructed on the memory, can access directly the memory /peripheral device and performs the data transfer operation.

It supports the software activation, the hardware activation and the chain activation functions.

A/D Converter (Max 24 channels)

[12-bit A/D Converter]

- Successive Approximation type
- Built-in 3 units
- Conversion time: 0.5 μs @ 5 V
- Priority conversion available (priority at 2levels)
- Scanning conversion mode
- Built-in FIFO for conversion data storage (for SCAN conversion: 16steps, for Priority conversion: 4steps)

D/A Converter (Max two channels)

- R-2R type
- 12-bit resolution

Base Timer (Max eight channels)

Operation mode is selectable from the followings for each channel.

- 16-bit PWM timer
- 16-bit PPG timer
- 16-/32-bit reload timer
- 16-/32-bit PWC timer

General Purpose I/O Port

This series can use its pins as general purpose I/O ports when they are not used for external bus or peripherals. Moreover, the port relocate function is built in. It can set which I/O port the peripheral function can be allocated.

- Capable of pull-up control per pin
- Capable of reading pin level directly
- Built-in the port relocate function
- Up to 100 high-speed general-purpose I/O ports @ 120 pin Package
- Some pin is 5 V tolerant I/O.

See 4. Pin Description and 5. I/O Circuit Type for the corresponding pins.

Multi-function Timer (Max two units)

The Multi-function timer is composed of the following blocks.

Minimum resolution: 6.25 ns

- 16-bit free-run timer × 3 ch./unit
- Input capture × 4 ch./unit
- Output compare × 6 ch./unit
- A/D activation compare × 6 ch./unit
- Waveform generator × 3 ch./unit
- 16-bit PPG timer × 3 ch./unit

The following function can be used to achieve the motor control.

- PWM signal output function
- DC chopper waveform output function
- Dead time function
- Input capture function
- A/D convertor activate function
- DTIF (Motor emergency stop) interrupt function

Real-time clock (RTC)

The Real-time clock can count

Year/Month/Day/Hour/Minute/Second/A day of the week from 00 to 99.

- Interrupt function with specifying date and time (Year/Month/Day/Hour/Minute) is available. This function is also available by specifying only Year, Month, Day, Hour or Minute.
- Timer interrupt function after set time or each set time.
- Capable of rewriting the time with continuing the time count.
- Leap year automatic count is available.

Quadrature Position/Revolution Counter (QPRC) (Max two channels)

The Quadrature Position/Revolution Counter (QPRC) is used to measure the position of the position encoder. Moreover, it is possible to use up/down counter.

- The detection edge of the three external event input pins AIN, BIN, and ZIN is configurable.
- 16-bit position counter
- 16-bit revolution counter
- Two 16-bit compare registers

Dual Timer (32-/16-bit Down Counter)

The Dual Timer consists of two programmable 32-/16-bit down counters.

Operation mode is selectable from the followings for each channel.

- Free-running
- Periodic (=Reload)
- One-shot

Watch Counter

The Watch counter is used for wake up from the low-power consumption mode. It is possible to select the main clock, sub clock, built-in high-speed CR clock or built-in low-speed CR clock as the clock source.

Interval timer: up to 64 s (Max) @ Sub Clock: 32.768 kHz

External Interrupt Controller Unit

- External interrupt input pin: Max 16 pins
- Include one non-maskable interrupt (NMI)

Watchdog Timer (two channels)

A watchdog timer can generate interrupts or a reset when a time-out value is reached.

This series consists of two different watchdogs, a "Hardware" watchdog and a "Software" watchdog.

"Hardware" watchdog timer is clocked by low-speed internal CR oscillator. Therefore, "Hardware" watchdog is active in any power saving mode except STOP.

CRC (Cyclic Redundancy Check) Accelerator

The CRC accelerator helps a verify data transmission or storage integrity.

CCITT CRC16 and IEEE-802.3 CRC32 are supported.

- CCITT CRC16 Generator Polynomial: 0x1021
- IEEE-802.3 CRC32 Generator Polynomial: 0x04C11DB7

SD Card Interface

It is possible to use the SD card that conforms to the following standards.

- Part 1 Physical Layer Specification version 3.01
- Part E1 SDIO Specification version 3.00
- Part A2 SD Host Controller Standard Specification version 3.00
- 1-bit or 4-bit data bus

Clock and Reset

■ Clocks

Five clock sources (2 external oscillators, 2 internal CR oscillator, and Main PLL) that are dynamically selectable.

- Main clock: 4 MHz to 48 MHz
- Sub Clock: 32.768 kHz
- High-speed internal CR Clock: 4 MHz
- Low-speed internal CR Clock: 100 kHz
- Main PLL Clock

■ Resets

- Reset requests from INITX pin
- Power on reset
- Software reset
- Watchdog timers reset
- Low voltage detector reset
- Clock supervisor reset

Clock Super Visor (CSV)

Clocks generated by internal CR oscillators are used to supervise abnormality of the external clocks.

- External OSC clock failure (clock stop) is detected, reset is asserted.
- External OSC frequency anomaly is detected, interrupt or reset is asserted.

Low-Voltage Detector (LVD)

This Series include 2-stage monitoring of voltage on the VCC pins. When the voltage falls below the voltage has been set, Low-Voltage Detector generates an interrupt or reset.

- LVD1: error reporting via interrupt
- LVD2: auto-reset operation

Low-power Consumption Mode

Six low-power consumption modes are supported.

- SLEEP
- TIMER
- RTC
- STOP
- Deep standby RTC (selectable from with/without RAM retention)
- Deep standby stop (selectable from with/without RAM retention)

VBAT

The consumption power during the RTC operation can be reduced by supplying the power supply independent from the RTC (calendar circuit)/32 kHz oscillation circuit. The following circuits can also be used.

- RTC
- 32 kHz oscillation circuit
- Power-on circuit
- Back up register: 32 bytes
- Port circuit

Debug

- Serial Wire JTAG Debug Port (SWJ-DP)
- Embedded Trace Macrocells (ETM) provide comprehensive debug and trace facilities.

Unique ID

Unique value of the device (41-bit) is set.

Power Supply

Three Power Supplies

- Wide range voltage:
VCC = 2.7 V to 5.5 V
- Power supply for USB I/O:
USBVCC = 3.0 V to 3.6 V (when USB is used)
= 2.7 V to 5.5 V (when GPIO is used)
- Power supply for VBAT:
VBAT = 2.7 V to 5.5 V

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1. Product Lineup

Memory Size

Product name	MB9BF566M/N/R	MB9BF567M/N/R	MB9BF568M/N/R
MainFlash memory	512 Kbytes	768 Kbytes	1024 Kbytes
WorkFlash memory	32 Kbytes	32 Kbytes	32 Kbytes
On-chip SRAM	64 Kbytes	96 Kbytes	128 Kbytes
SRAM0	32 Kbytes	48 Kbytes	64 Kbytes
SRAM1	16 Kbytes	24 Kbytes	32 Kbytes
SRAM1	16 Kbytes	24 Kbytes	32 Kbytes

Function

Product name	MB9BF566M MB9BF567M MB9BF568M	MB9BF566N MB9BF567N MB9BF568N	MB9BF566R MB9BF567R MB9BF568R
Pin count	80	100/112	120/144
CPU	Cortex-M4F, MPU, NVIC 128ch.		
Freq.	160 MHz		
Power supply voltage range	2.7 V to 5.5 V		
USB2.0 (Device/Host)	1ch.		
CAN	2ch. (Max)		
DMAC	8ch.		
DSTC	128ch.		
External Bus Interface	Addr:19-bit (Max), R/W data: 8-bit (Max), CS:5 (Max), SRAM, NOR Flash	Addr:25-bit (Max), R/W data: 8-/16-bit (Max), CS:9 (Max), SRAM, NOR Flash, SDRAM	Addr:25-bit (Max), R/W data: 8-/16-bit (Max), CS:9 (Max), SRAM, NOR Flash, NAND Flash, SDRAM
Multi-function Serial Interface (UART/CSIO/LIN/I ² C)	8ch. (Max)		
Base Timer (PWC/Reload timer/PWM/PPG)	8ch. (Max)		
MF Timer	A/D activation compare	6ch.	2 units (Max)
	Input capture	4ch.	
	Free-run timer	3ch.	
	Output compare	6ch.	
	Waveform generator	3ch.	
PPG	3ch.		
SD Card Interface	1 unit		
QPRC	2ch. (Max)		
Dual Timer	1 unit		
Real-Time Clock	1 unit		
Watch Counter	1 unit		
CRC Accelerator	Yes		
Watchdog Timer	1ch. (SW) + 1ch. (HW)		
External Interrupts	16 pins (Max) + NMI × 1		
I/O Ports	63 pins (Max)	80 pins (Max)	100 pins (Max)
12-bit A/D Converter	16ch. (3 units)	24ch. (3 units)	
12-bit D/A Converter	2 units (Max)		
CSV (Clock Super Visor)	Yes		
LVD (Low-Voltage Detector)	2ch.		
Built-in CR	High-speed	4 MHz	
	Low-speed	100 kHz	
Debug Function	SWJ-DP/ETM		
Unique ID	Yes		

Notes:

- All signals of the peripheral function in each product cannot be allocated by limiting the pins of package. It is necessary to use the port relocate function of the I/O port according to your function use.
- See "12. Electrical Characteristics 12.4. AC Characteristics 12.4.3. Built-in CR Oscillation Characteristics" for accuracy of built-in CR.

2. Packages

Product Name Package	MB9BF566M MB9BF567M MB9BF568M	MB9BF566N MB9BF567N MB9BF568N	MB9BF566R MB9BF567R MB9BF568R
LQFP: LQH080 (0.5 mm pitch)	○	-	-
LQFP: LQJ080 (0.65 mm pitch)	○	-	-
QFP: PQH100 (0.65 mm pitch)	-	○	-
LQFP: LQI100 (0.5 mm pitch)	-	○	-
LQFP: LQM120 (0.5 mm pitch)	-	-	○
BGA: LDC112 (0.5 mm pitch)	-	○	-
BGA: LDC144 (0.5 mm pitch)	-	-	○

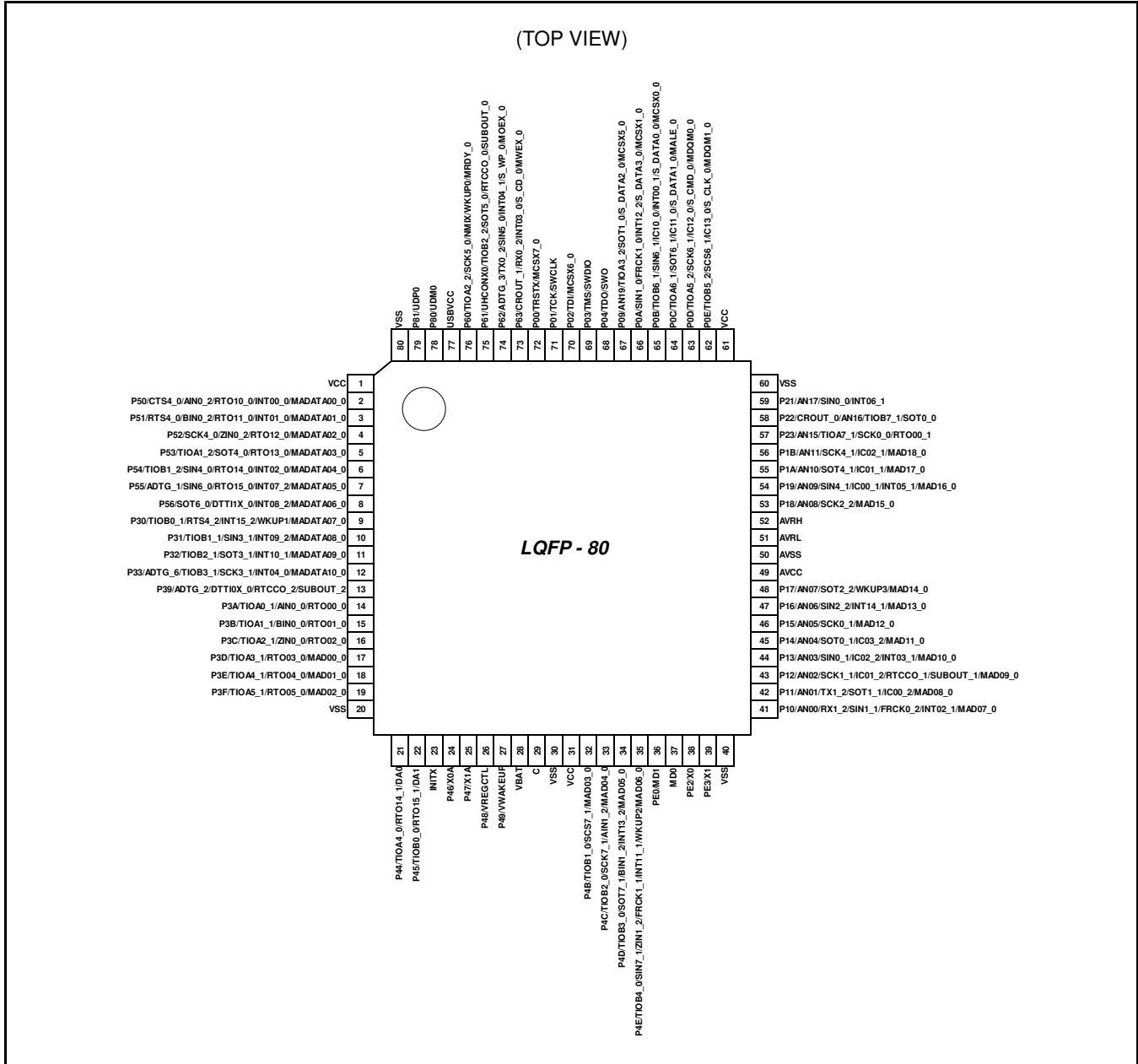
○: Supported

Note:

- See 14. Package Dimensions for detailed information on each package.

3. Pin Assignment

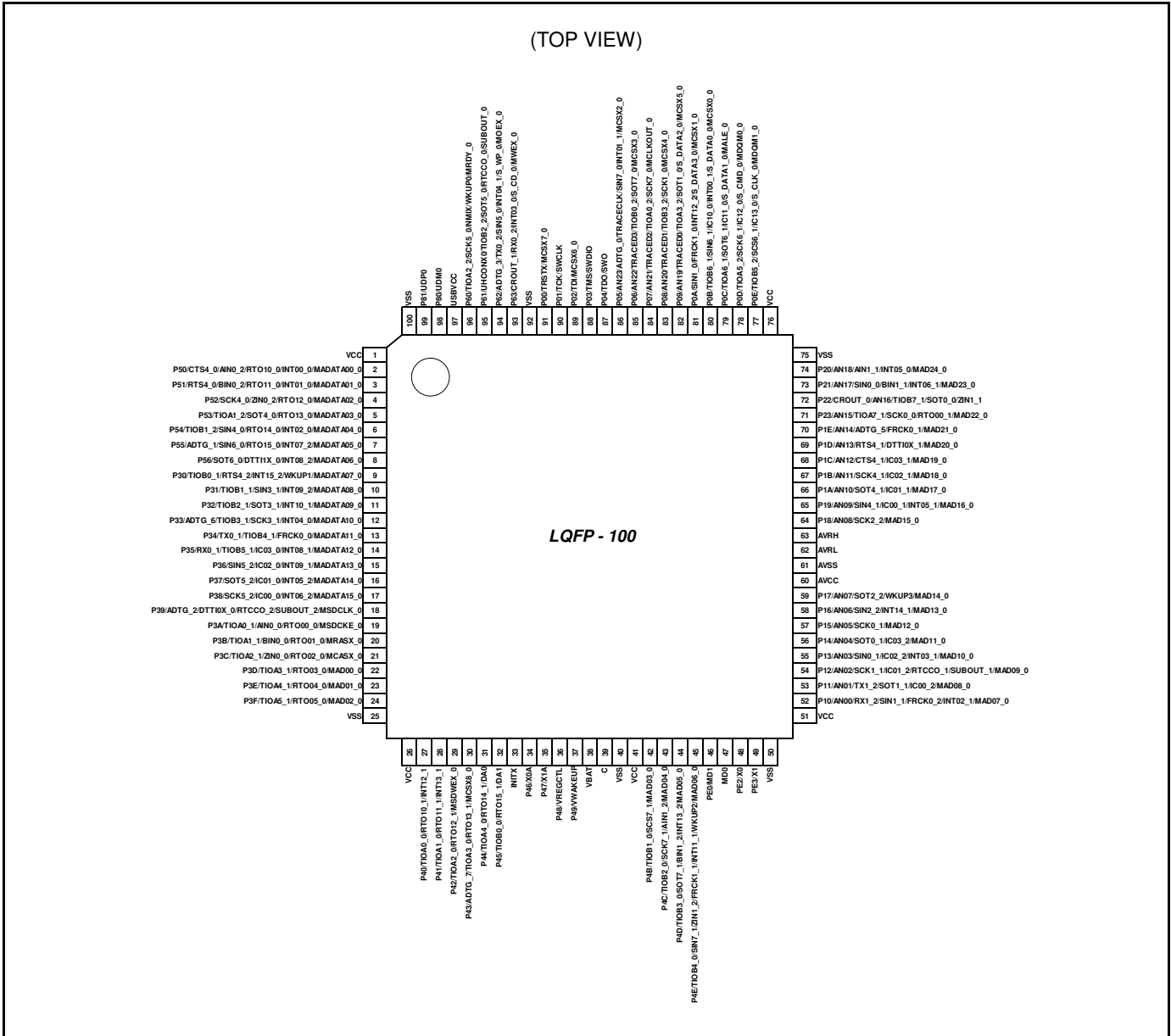
LQH080/LQJ080



Note:

- The number after the underscore ("_") in pin names such as XXX_1 and XXX_2 indicates the relocated port number. For these pins, there are multiple pins that provide the same function for the same channel. Use the extended port function register (EPFR) to select the pin.

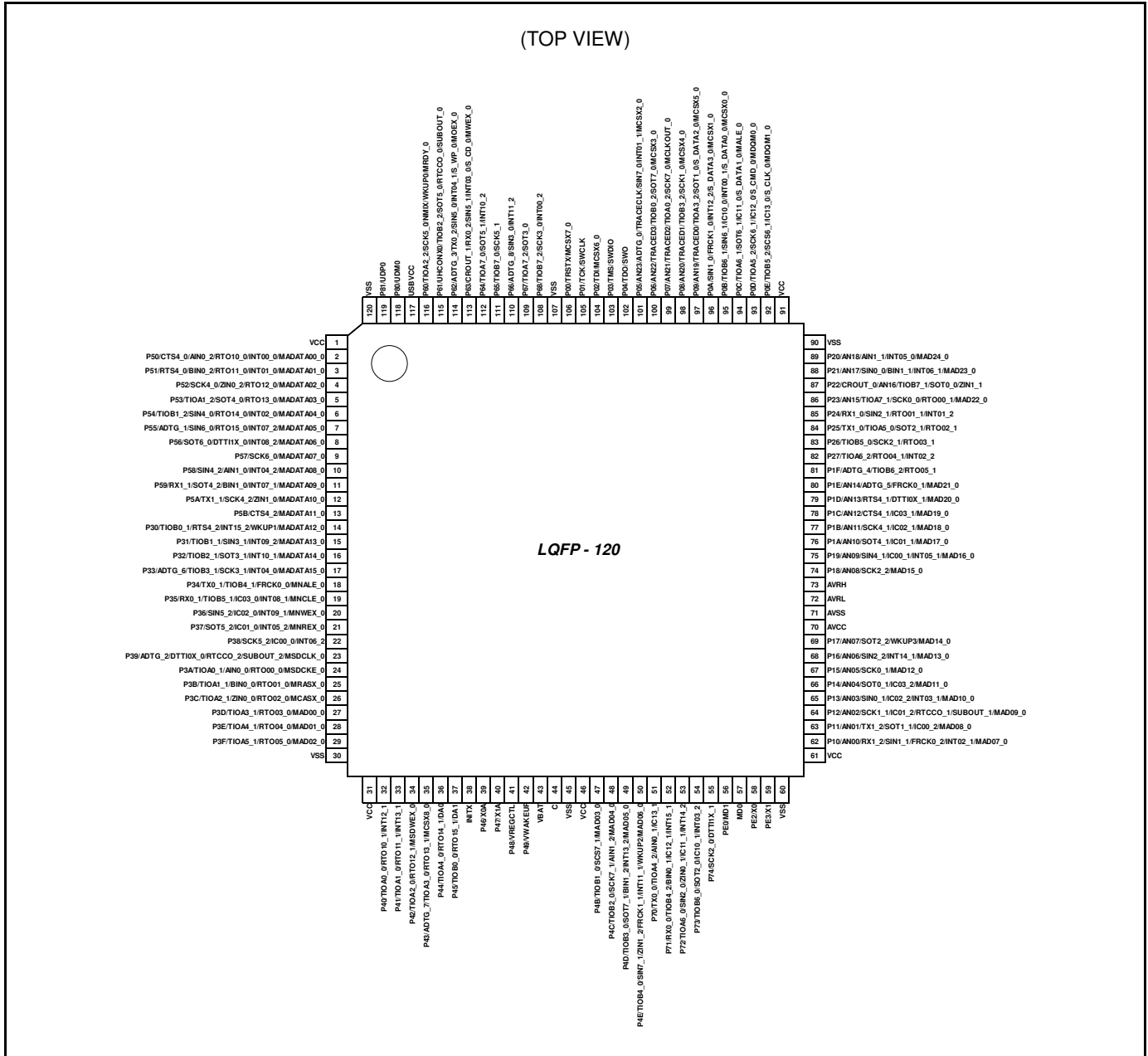
LQ1100



Note:

- The number after the underscore ("_") in pin names such as XXX_1 and XXX_2 indicates the relocated port number. For these pins, there are multiple pins that provide the same function for the same channel. Use the extended port function register (EPFR) to select the pin.

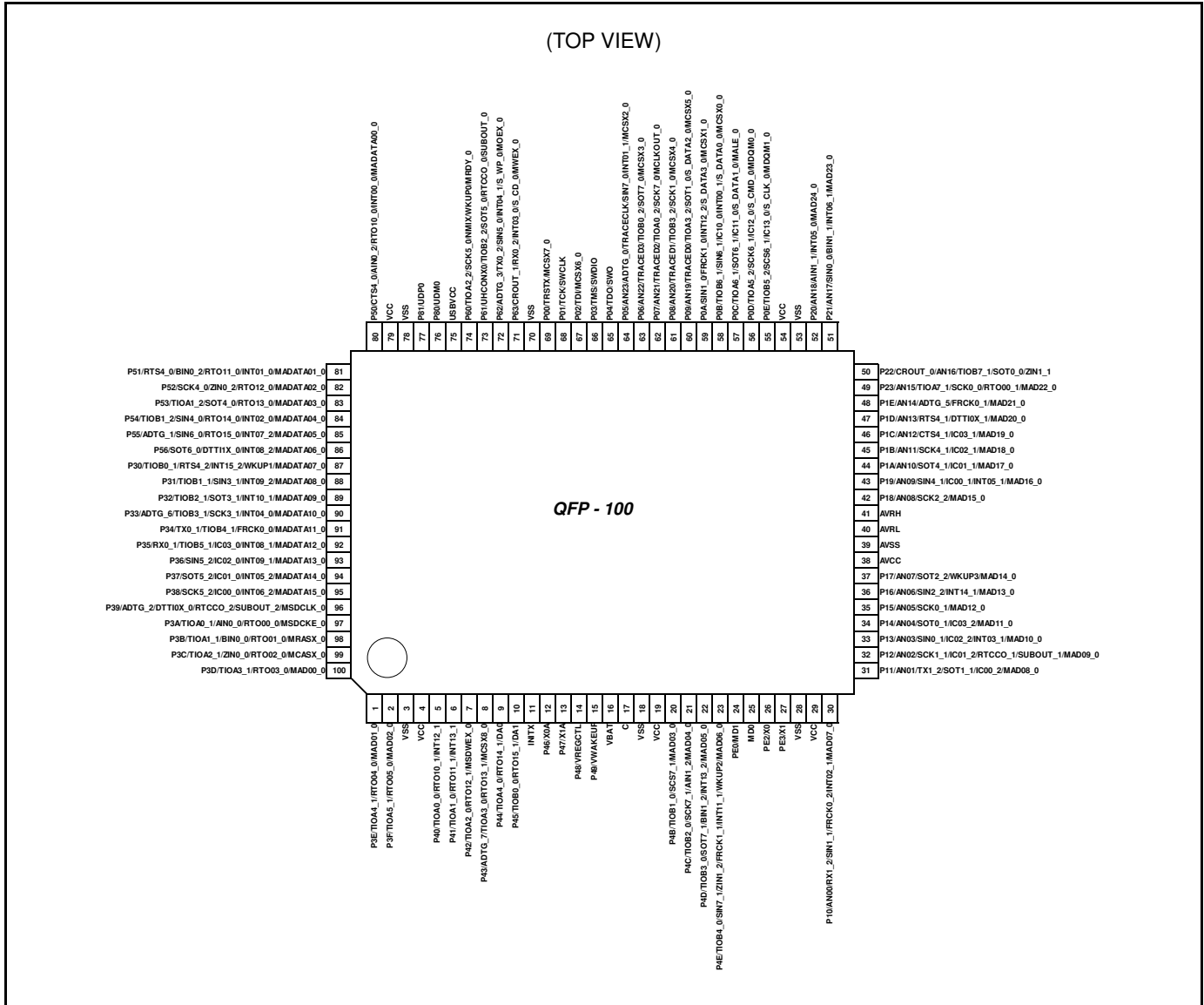
LQM120



Note:

- The number after the underscore ("_") in pin names such as XXX_1 and XXX_2 indicates the relocated port number. For these pins, there are multiple pins that provide the same function for the same channel. Use the extended port function register (EPFR) to select the pin.

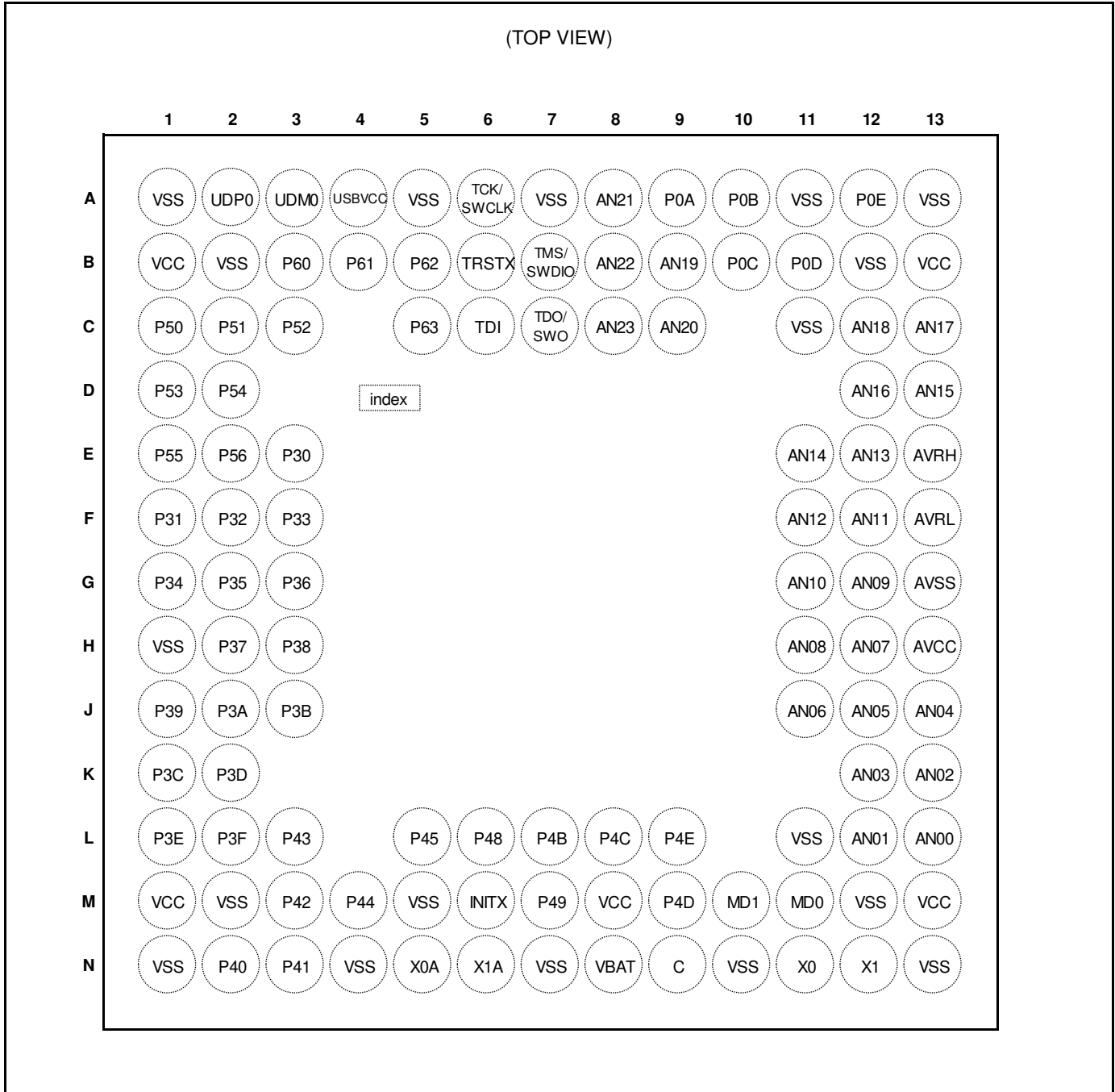
PQH100



Note:

- The number after the underscore ("_") in pin names such as XXX_1 and XXX_2 indicates the relocated port number. For these pins, there are multiple pins that provide the same function for the same channel. Use the extended port function register (EPFR) to select the pin.

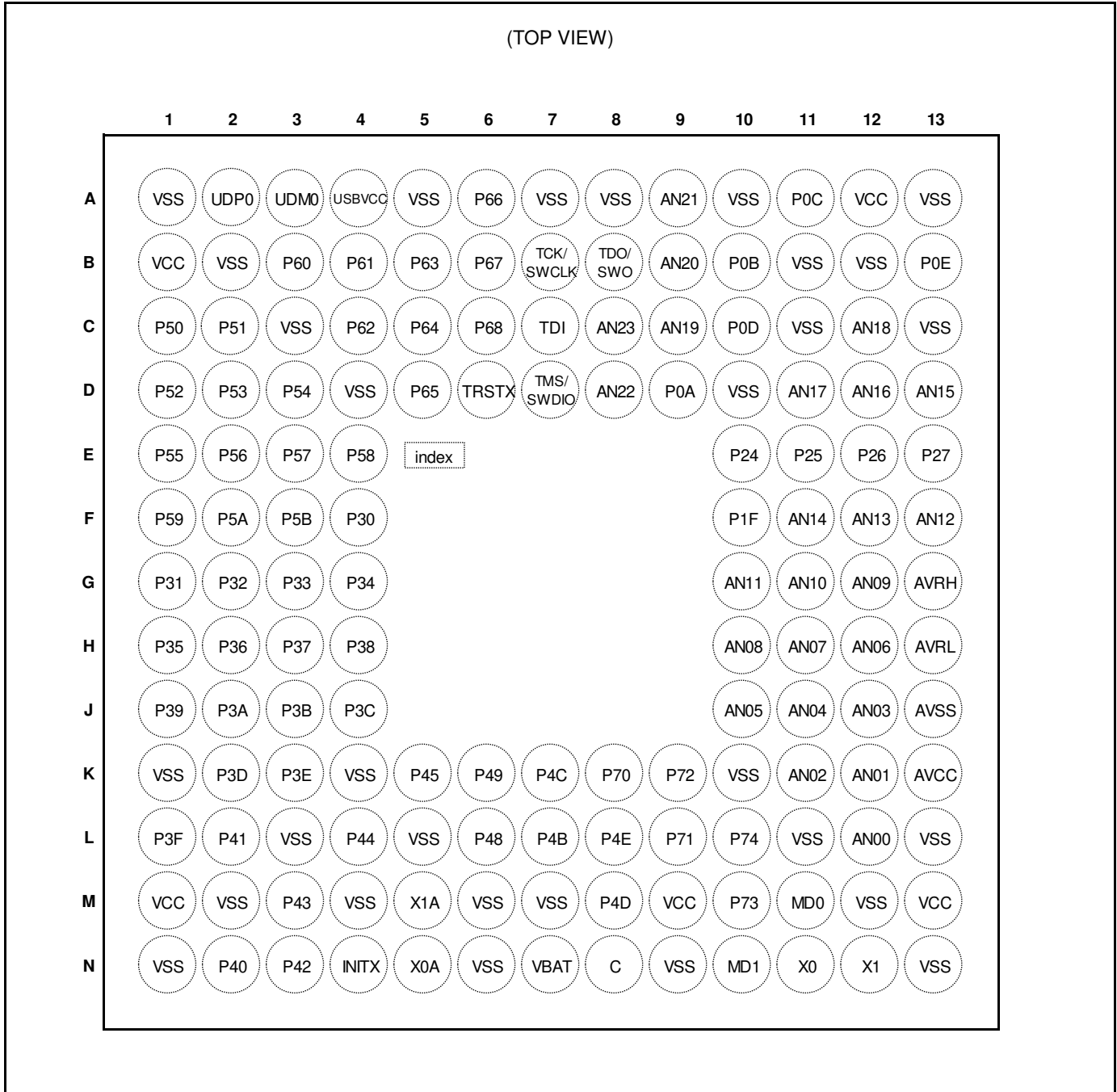
LDC112



Note:

- The number after the underscore ("_") in pin names such as XXX_1 and XXX_2 indicates the relocated port number. For these pins, there are multiple pins that provide the same function for the same channel. Use the extended port function register (EPFR) to select the pin.

LDC144



Note:

- The number after the underscore ("_") in pin names such as XXX_1 and XXX_2 indicates the relocated port number. For these pins, there are multiple pins that provide the same function for the same channel. Use the extended port function register (EPFR) to select the pin.

4. Pin Description

4.1 List of Pin Numbers

The number after the underscore ("_") in pin names such as XXX_1 and XXX_2 indicates the relocated port number. For these pins, there are multiple pins that provide the same function for the same channel. Use the extended port function register (EPFR) to select the pin.

Pin No						Pin Name	I/O Circuit Type	Pin State Type
LQFP120	LQFP100	LQFP80	QFP100	BGA112	BGA144			
1	1	1	79	B1	B1	VCC	-	-
2	2	2	80	C1	C1	P50	E	K
						CTS4_0		
						AIN0_2		
						RTO10_0 (PPG10_0)		
						INT00_0		
MADATA00_0								
3	3	3	81	C2	C2	P51	E	K
						RTS4_0		
						BIN0_2		
						RTO11_0 (PPG10_0)		
						INT01_0		
MADATA01_0								
4	4	4	82	C3	D1	P52	E	I
						SCK4_0 (SCL4_0)		
						ZIN0_2		
						RTO12_0 (PPG12_0)		
MADATA02_0								
5	5	5	83	D1	D2	P53	E	I
						TIOA1_2		
						SOT4_0 (SDA4_0)		
						RTO13_0 (PPG12_0)		
MADATA03_0								
6	6	6	84	D2	D3	P54	E	K
						TIOB1_2		
						SIN4_0		
						RTO14_0 (PPG14_0)		
						INT02_0		
MADATA04_0								

Pin No						Pin Name	I/O Circuit Type	Pin State Type
LQFP120	LQFP100	LQFP80	QFP100	BGA112	BGA144			
7	7	7	85	E1	E1	P55	E	K
						ADTG_1		
						SIN6_0		
						RTO15_0 (PPG14_0)		
						INT07_2		
						MADATA05_0		
8	8	8	86	E2	E2	P56	E	K
						SOT6_0 (SDA6_0)		
						DTTI1X_0		
						INT08_2 MADATA06_0		
9	-	-	-	-	E3	P57	E	I
						SCK6_0 (SCL6_0)		
						MADATA07_0		
10	-	-	-	-	E4	P58	E	K
						SIN4_2		
						AIN1_0		
						INT04_2 MADATA08_0		
11	-	-	-	-	F1	P59	E	K
						RX1_1		
						SOT4_2 (SDA4_2)		
						BIN1_0		
						INT07_1 MADATA09_0		
12	-	-	-	-	F2	P5A	E	I
						TX1_1		
						SCK4_2 (SCL4_2)		
						ZIN1_0		
						MADATA10_0		
13	-	-	-	-	F3	P5B	E	I
						CTS4_2		
						MADATA11_0		
14	9	9	87	E3	F4	P30	E	Q
						TIOB0_1		
						RTS4_2		
						INT15_2		
						WKUP1		
-	-	-	-	-	-	MADATA07_0		
14	-	-	-	-	F4	MADATA12_0		

Pin No						Pin Name	I/O Circuit Type	Pin State Type
LQFP120	LQFP100	LQFP80	QFP100	BGA112	BGA144			
15	10	10	88	F1	G1	P31	I	K
						TIOB1_1		
						SIN3_1		
						INT09_2		
-	-	-	-	-	-	MADATA08_0		
15	-	-	-	-	G1	MADATA13_0		
16	11	11	89	F2	G2	P32	N	K
						TIOB2_1		
						SOT3_1 (SDA3_1)		
						INT10_1		
-	-	-	-	-	-	MADATA09_0		
16	-	-	-	-	G2	MADATA14_0		
17	12	12	90	F3	G3	P33	N	K
						ADTG_6		
						TIOB3_1		
						SCK3_1 (SCL3_1)		
-	-	-	-	-	-	MADATA10_0		
17	-	-	-	-	G3	MADATA15_0		
18	13	-	91	G1	G4	P34	E	I
						TX0_1		
						TIOB4_1		
						FRCK0_0		
-	-	-	-	-	-	MADATA11_0		
18	-	-	-	-	G4	MNALE_0		
19	14	-	92	G2	H1	P35	E	K
						RX0_1		
						TIOB5_1		
						IC03_0		
-	-	-	-	-	-	INT08_1		
19	-	-	-	-	H1	MADATA12_0		
20	15	-	93	G3	H2	P36	E	K
						SIN5_2		
						IC02_0		
						INT09_1		
-	-	-	-	-	-	MADATA13_0		
20	-	-	-	-	H2	MNWEX_0		
21	16	-	94	H2	H3	P37	E	K
						SOT5_2 (SDA5_2)		
						IC01_0		
						INT05_2		
-	-	-	-	-	-	MADATA14_0		
21	-	-	-	-	H3	MNREX_0		

Pin No						Pin Name	I/O Circuit Type	Pin State Type
LQFP120	LQFP100	LQFP80	QFP100	BGA112	BGA144			
22	17	-	95	H3	H4	P38	E	K
						SCK5_2 (SCL5_2)		
						IC00_0		
						INT06_2		
-	-	-	-	-	-	MADATA15_0	-	-
23	18	13	96	J1	J1	P39	L	I
						ADTG_2		
						DTTIOX_0		
		RTCCO_2						
		SUBOUT_2						
-	-	-	-	-	-	MSDCLK_0	-	-
24	19	14	97	J2	J2	P3A	G	I
						TIOA0_1		
						AIN0_0		
		RTO00_0 (PPG00_0)						
-	-	-	-	-	-	MSDCKE_0	-	-
25	20	15	98	J3	J3	P3B	G	I
						TIOA1_1		
						BIN0_0		
		RTO01_0 (PPG00_0)						
-	-	-	-	-	-	MRASX_0	-	-
26	21	16	99	K1	J4	P3C	G	I
						TIOA2_1		
						ZIN0_0		
		RTO02_0 (PPG02_0)						
-	-	-	-	-	-	MCASX_0	-	-
27	22	17	100	K2	K2	P3D	G	I
						TIOA3_1		
						RTO03_0 (PPG02_0)		
						MAD00_0		
28	23	18	1	L1	K3	P3E	G	I
						TIOA4_1		
						RTO04_0 (PPG04_0)		
						MAD01_0		
29	24	19	2	L2	L1	P3F	G	I
						TIOA5_1		
						RTO05_0 (PPG04_0)		
						MAD02_0		
30	25	20	3	N1	N1	VSS	-	-
31	26	-	4	M1	M1	VCC	-	-

Pin No						Pin Name	I/O Circuit Type	Pin State Type
LQFP120	LQFP100	LQFP80	QFP100	BGA112	BGA144			
32	27	-	5	N2	N2	P40	G	K
						TIOA0_0		
						RTO10_1 (PPG10_1)		
						INT12_1		
33	28	-	6	N3	L2	P41	G	K
						TIOA1_0		
						RTO11_1 (PPG10_1)		
						INT13_1		
34	29	-	7	M3	N3	P42	G	I
						TIOA2_0		
						RTO12_1 (PPG12_1)		
						MSDWEX_0		
35	30	-	8	L3	M3	P43	G	I
						ADTG_7		
						TIOA3_0		
						RTO13_1 (PPG12_1)		
						MCSX8_0		
36	31	21	9	M4	L4	P44	R	J
						TIOA4_0		
						RTO14_1 (PPG14_1)		
						DA0		
37	32	22	10	L5	K5	P45	R	J
						TIOB0_0		
						RTO15_1 (PPG14_1)		
						DA1		
38	33	23	11	M6	N4	INITX	B	C
39	34	24	12	N5	N5	P46	P	S
						X0A		
40	35	25	13	N6	M5	P47	Q	T
						X1A		
41	36	26	14	L6	L6	P48	O	U
						VREGCTL		
42	37	27	15	M7	K6	P49	O	U
						VWAKEUP		
43	38	28	16	N8	N7	VBAT	-	-
44	39	29	17	N9	N8	C	-	-
45	40	30	18	N10	N9	VSS	-	-
46	41	31	19	M8	M9	VCC	-	-
47	42	32	20	L7	L7	P4B	E	I
						TIOB1_0		
						SCS7_1		
						MAD03_0		

Pin No						Pin Name	I/O Circuit Type	Pin State Type
LQFP120	LQFP100	LQFP80	QFP100	BGA112	BGA144			
48	43	33	21	L8	K7	P4C	N	I
						TIOB2_0		
						SCK7_1 (SCL7_1)		
						AIN1_2		
						MAD04_0		
49	44	34	22	M9	M8	P4D	N	K
						TIOB3_0		
						SOT7_1 (SDA7_1)		
						BIN1_2		
						INT13_2		
MAD05_0								
50	45	35	23	L9	L8	P4E	I	Q
						TIOB4_0		
						SIN7_1		
						ZIN1_2		
						FRCK1_1		
						INT11_1		
						WKUP2		
						MAD06_0		
51	-	-	-	-	K8	P70	E	I
						TX0_0		
						TIOA4_2		
						AIN0_1		
						IC13_1		
52	-	-	-	-	L9	P71	E	K
						RX0_0		
						TIOB4_2		
						BIN0_1		
						IC12_1		
INT15_1								
53	-	-	-	-	K9	P72	E	K
						TIOA6_0		
						SIN2_0		
						ZIN0_1		
						IC11_1		
						INT14_2		
54	-	-	-	-	M10	P73	E	K
						TIOB6_0		
						SOT2_0 (SDA2_0)		
						IC10_1		
INT03_2								
55	-	-	-	-	L10	P74	E	I
						SCK2_0 (SCL2_0)		
						DTT1X_1		

Pin No						Pin Name	I/O Circuit Type	Pin State Type
LQFP120	LQFP100	LQFP80	QFP100	BGA112	BGA144			
56	46	36	24	M10	N10	PE0	C	E
						MD1		
57	47	37	25	M11	M11	MD0	J	D
58	48	38	26	N11	N11	PE2	A	A
						X0		
59	49	39	27	N12	N12	PE3	A	B
						X1		
60	50	40	28	N13	N13	VSS	-	-
61	51	-	29	M13	M13	VCC	-	-
62	52	41	30	L13	L12	P10	F	M
						AN00		
						RX1_2		
						SIN1_1		
						FRCK0_2		
						INT02_1		
						MAD07_0		
63	53	42	31	L12	K12	P11	F	L
						AN01		
						TX1_2		
						SOT1_1 (SDA1_1)		
						IC00_2		
						MAD08_0		
64	54	43	32	K13	K11	P12	F	L
						AN02		
						SCK1_1 (SCL1_1)		
						IC01_2		
						RTCCO_1		
						SUBOUT_1		
						MAD09_0		
65	55	44	33	K12	J12	P13	F	M
						AN03		
						SIN0_1		
						IC02_2		
						INT03_1		
						MAD10_0		
66	56	45	34	J13	J11	P14	F	L
						AN04		
						SOT0_1 (SDA0_1)		
						IC03_2		
						MAD11_0		
67	57	46	35	J12	J10	P15	F	L
						AN05		
						SCK0_1 (SCL0_1)		
						MAD12_0		

Pin No						Pin Name	I/O Circuit Type	Pin State Type
LQFP120	LQFP100	LQFP80	QFP100	BGA112	BGA144			
68	58	47	36	J11	H12	P16	F	M
						AN06		
						SIN2_2		
						INT14_1		
						MAD13_0		
69	59	48	37	H12	H11	P17	F	P
						AN07		
						SOT2_2 (SDA2_2)		
						WKUP3		
						MAD14_0		
70	60	49	38	H13	K13	AVCC	-	-
71	61	50	39	G13	J13	AVSS	-	-
72	62	51	40	F13	H13	AVRL	-	-
73	63	52	41	E13	G13	AVRH	-	-
74	64	53	42	H11	H10	P18	F	L
						AN08		
						SCK2_2 (SCL2_2)		
						MAD15_0		
75	65	54	43	G12	G12	P19	F	M
						AN09		
						SIN4_1		
						IC00_1		
						INT05_1		
						MAD16_0		
76	66	55	44	G11	G11	P1A	M	L
						AN10		
						SOT4_1 (SDA4_1)		
						IC01_1		
						MAD17_0		
77	67	56	45	F12	G10	P1B	M	L
						AN11		
						SCK4_1 (SCL4_1)		
						IC02_1		
						MAD18_0		
78	68	-	46	F11	F13	P1C	F	L
						AN12		
						CTS4_1		
						IC03_1		
						MAD19_0		
79	69	-	47	E12	F12	P1D	F	L
						AN13		
						RTS4_1		
						DTTIOX_1		
						MAD20_0		

Pin No						Pin Name	I/O Circuit Type	Pin State Type
LQFP120	LQFP100	LQFP80	QFP100	BGA112	BGA144			
80	70	-	48	E11	F11	P1E	F	L
						AN14		
						ADTG_5		
						FRCK0_1		
						MAD21_0		
81	-	-	-	-	F10	P1F	E	I
						ADTG_4		
						TIOB6_2		
						RTO05_1 (PPG04_1)		
82	-	-	-	-	E13	P27	E	K
						TIOA6_2		
						RTO04_1 (PPG04_1)		
						INT02_2		
83	-	-	-	-	E12	P26	E	I
						TIOB5_0		
						SCK2_1 (SCL2_1)		
						RTO03_1 (PPG02_1)		
84	-	-	-	-	E11	P25	E	I
						TX1_0		
						TIOA5_0		
						SOT2_1 (SDA2_1)		
						RTO02_1 (PPG02_1)		
85	-	-	-	-	E10	P24	E	K
						RX1_0		
						SIN2_1		
						RTO01_1 (PPG00_1)		
						INT01_2		
86	71	57	49	D13	D13	P23	F	L
		-						
		-						
		-						
		-						
		-						
						AN15		
						TIOA7_1		
						SCK0_0 (SCL0_0)		
						RTO00_1 (PPG00_1)		
						MAD22_0		

Pin No						Pin Name	I/O Circuit Type	Pin State Type
LQFP120	LQFP100	LQFP80	QFP100	BGA112	BGA144			
87	72	58	50	D12	D12	P22	F	L
						CROUT_0		
						AN16		
						TIOB7_1		
						SOT0_0 (SDA0_0)		
		ZIN1_1						
-								
88	73	59	51	C13	D11	P21	F	M
						AN17		
						SIN0_0		
						BIN1_1		
						INT06_1		
		MAD23_0						
-								
89	74	-	52	C12	C12	P20	F	M
						AN18		
						AIN1_1		
						INT05_0		
						MAD24_0		
90	75	60	53	A13	A13	VSS	-	-
91	76	61	54	B13	A12	VCC	-	-
92	77	62	55	A12	B13	P0E	L	I
						TIOB5_2		
						SCS6_1		
						IC13_0		
						S_CLK_0		
						MDQM1_0		
93	78	63	56	B11	C10	P0D	L	I
						TIOA5_2		
						SCK6_1 (SCL6_1)		
						IC12_0		
						S_CMD_0		
						MDQM0_0		
94	79	64	57	B10	A11	P0C	L	I
						TIOA6_1		
						SOT6_1 (SDA6_1)		
						IC11_0		
						S_DATA1_0		
						MALE_0		
95	80	65	58	A10	B10	P0B	L	K
						TIOB6_1		
						SIN6_1		
						IC10_0		
						INT00_1		
						S_DATA0_0		
MCSX0_0								

Pin No						Pin Name	I/O Circuit Type	Pin State Type
LQFP120	LQFP100	LQFP80	QFP100	BGA112	BGA144			
96	81	66	59	A9	D9	P0A	L	K
						SIN1_0		
						FRCK1_0		
						INT12_2		
						S_DATA3_0		
						MCSX1_0		
97	82	67	60	B9	C9	P09	M	N
		-				AN19		
		67				TRACED0		
						TIOA3_2		
						SOT1_0 (SDA1_0)		
						S_DATA2_0		
MCSX5_0								
98	83	-	61	C9	B9	P08	F	N
						AN20		
						TRACED1		
						TIOB3_2		
						SCK1_0 (SCL1_0)		
						MCSX4_0		
99	84	-	62	A8	A9	P07	F	N
						AN21		
						TRACED2		
						TIOA0_2		
						SCK7_0 (SCL7_0)		
						MCLKOUT_0		
100	85	-	63	B8	D8	P06	F	N
						AN22		
						TRACED3		
						TIOB0_2		
						SOT7_0 (SDA7_0)		
						MCSX3_0		
101	86	-	64	C8	C8	P05	F	O
						AN23		
						ADTG_0		
						TRACECLK		
						SIN7_0		
						INT01_1		
MCSX2_0								
102	87	68	65	C7	B8	P04	E	G
						TDO		
						SWO		
103	88	69	66	B7	D7	P03	E	G
						TMS		
						SWDIO		